

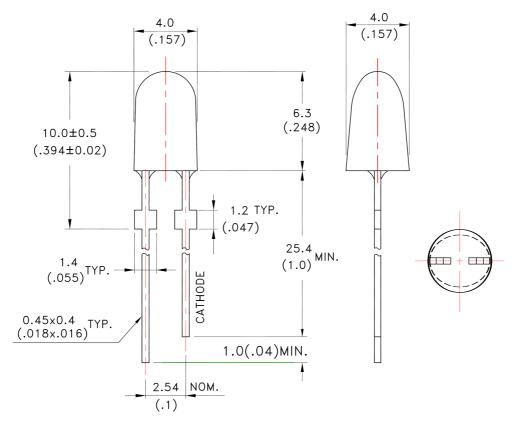
# LITEON \* LITE-ON TECHNOLOGY CORPORATION

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#### **Features**

- \* Lead (Pb) free product and RoHS compliant.
- \* High luminous intensity output.
- \* Low power consumption.
- \* High efficiency.
- \* Versatile mounting on P.C. board or panel.
- \* I.C. Compatible/low current requirements.
- \* Widely viewing angle.

#### **Package Dimensions**



Part No.	Lens	Source Color
LTL4HMEPADS-012A	Red Diffused	AlInGaP Red

#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25$ mm (.010") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.
- 5. The LED lamp original is LTL4HMEPADS

Part No.: LTL4HMEPADS-012A	Page:	1	of	11		
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# Absolute Maximum Ratings at $TA=25^{\circ}C$

Parameter	Maximum Rating Un	
Power Dissipation	125	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	90 m	
Continuous Forward Current	50	mA
Derating Linear From 40°C	0.64	mA/°C
Reverse Voltage	5	V
Operating Temperature Range	-40°C to + 85°C	
Storage Temperature Range	-55°C to + 105°C	
Lead Soldering Temperature [2.0mm(.078") From Body]	260°C for 5 Seconds Max.	

Part No.: LTL4HMEPADS-012A Page: 2 of 11



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## Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv	520		1500	mcd	I <sub>F</sub> = 20mA Note 1,5
Viewing Angle	201/2		110/50		deg	I <sub>F</sub> = 20mA Note 2 (Fig.6)
Peak Emission Wavelength	λР		631		nm	IF = 20mA Measurement @Peak (Fig.1)
Dominant Wavelength	$\lambda_{ m d}$	617	624	629	nm	$I_F = 20$ mA, Note 4
Spectral Line Half-Width	Δλ		20		nm	I <sub>F</sub> = 20mA
Forward Voltage	VF	1.8	2.1	2.5	V	$I_F = 20 \text{mA}$
Reverse Current	$I_R$			100	μΑ	$V_R = 5V$

NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2.  $\theta_{1/2}$  is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. Iv classification code is marked on each packing bag.
- 4. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 5. The Iv guarantee should be added  $\pm 15\%$ .

of Part No.: LTL4HMEPADS-012A Page: 11



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### Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

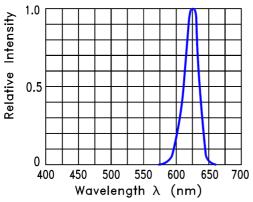


Fig.1 Relative Intensity VS. Wavelength

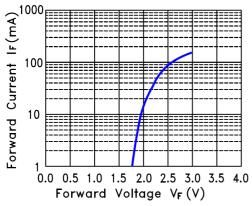


Fig.3 Forward Current vs. Forward Voltage

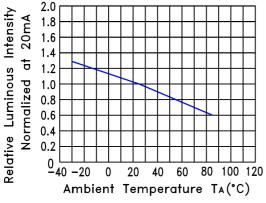


Fig.5 Relative Luminous Intensity VS. Ambient Temperature

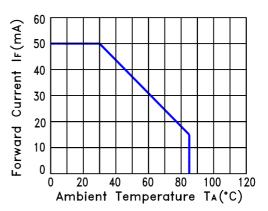


Fig.2 Forward Current Derating Curve

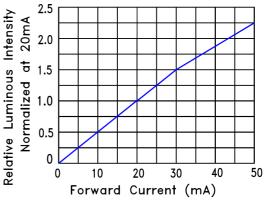


Fig.4 Relative Luminous Intensity vs. Forward Current

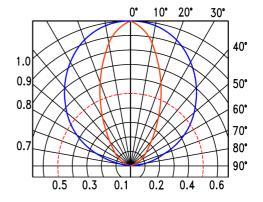


Fig.6 Spatial Distribution

Part No.: LTL4HMEPADS-012A Page: 4 of 11

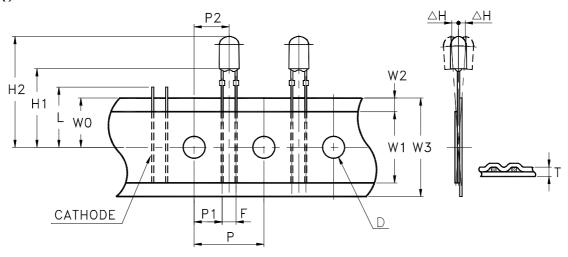


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#### **Features**

- \* Compatible with radial lead automatic insertion equipment.
- \* Most radial lead plastic lead lamps available packaged in tape and folding.
- \* 2.54mm (0.1") straight lead spacing available.
- \* Folding packaging simplifies handling and testing.

## **Package Dimensions**



TAPE	FEED	DIRECTION
		_

		Specification				
Item	Symbol	Minimum		Maximum		
		mm	inch	mm	inch	
Tape Feed Hole Diameter	D	3.8	0.149	4.2	0.165	
Component Lead Pitch	F	2.3	0.091	3.0	0.118	
Front to Rear Deflection	$\triangle H$			2.0	0.078	
Feed Hole to Bottom of Component	H1	21.5	0.846	22.5	0.886	
Feed Hole to Overall Component Height	H2	27.5	1.083	29.1	1.146	
Lead Length After Component Height	L	W	70	11.0	0.433	
Feed Hole Pitch	P	12.4	0.488	13.0	0.511	
Lead Location	P1	4.4	0.173	5.8	0.228	
Center of Component Location	P2	5.05	0.198	7.65	0.301	
Total Tape Thickness	T			0.90	0.035	
Feed Hole Location	W0	8.5	0.334	9.75	0.384	
Adhesive Tape Position	W2	0	0	3.0	0.118	
Tape Width	W3	17.5	0.689	19.0	0.748	

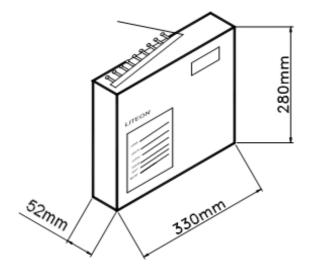
Part No.: LTL4HMEPADS-012A	Page:	5	of	11	
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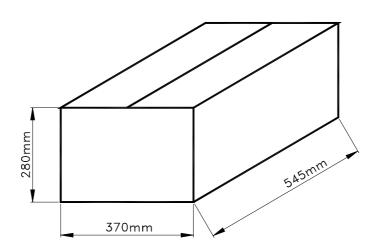
# Packing Spec

# 2,000 pcs per inner carton



Tolerance: ±5mm

10 Inner cartons per outer carton total 20,000 pcs per outer carton In every shipping lot, only the last pack will be non-full packing



Part No.: LTL4HMEPADS-012A Page: of 11



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# **Bin Table Specifications**

Luminous 1	Intensity Unit: 1	ncd @20mA
Bin Code	Min.	Max.
M	520	680
N	680	880
P	880	1150
Q	1150	1500

Note: Tolerance of each bin limit is  $\pm 15\%$ 

Dominant W	Vavelength Unit:	nm @20mA
Bin Code	Min.	Max.
H28	617.0	621.0
H29	621.0	625.0
H30	625.0	629.0

Note: Tolerance of each bin limit is ±1nm

Page: 7 Part No.: LTL4HMEPADS-012A of 11



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#### **CAUTIONS**

#### 1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

#### 2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

#### 3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

#### 4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens.

Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

#### 5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens to the soldering point.

Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Solderi	ng iron	Wave soldering	
Temperature Soldering time	300°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	100°C Max. 60 sec. Max. 260°C Max. 5 sec. Max.

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for through hole type LED lamp product.

Part No.: LTL4HMEPADS-012A Page: 8 of 11



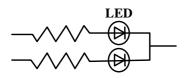
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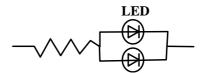
#### 6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

#### Circuit model A



#### Circuit model B



- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

#### 7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

Part No. LTL4HMEPADS-012A

Page:

of

11



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### Suggested checking list:

#### Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

#### Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

#### Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V\*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date?

Note: \*50V for Blue LED.

#### **Device Handling**

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

#### Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

Part No.: LTL4HMEPADS-012A Page: 10 of 11



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Classification	Test Item	Test Condition	Sample Size	Reference Standard
	Operation Life	Ta = 25℃  IF = 50mA *Test Time= 1000hrs	45 PCS (CL=90%; LTPD=5%)	MIL-STD-750D:1026 (1995) MIL-STD-883G:1005 (2006)
	High Temperature/ High Humidity storage (THB)	Ta = 85°C RH = 85% *Test Time= 1000hrs	45 PCS (CL=90%; LTPD=5%)	MIL-STD-202G:103B (2002) JEITA ED-4701:100 103 (2001)
Endurance	Steady state Operation Life of High Humidity Heat	Ta = 85℃, RH= 85 % IF = 30mA *Test Time= 500hrs	76 PCS (CL=90%; LTPD=3%)	JESD22-A101C (2009)
Fest Fest	Low Temperature Operation Life of	Ta = -30℃  IF = 50mA *Test Time= 1000hrs	45 PCS (CL=90%; LTPD=5%)	
	High Temperature Storage	Ta= 105 ± 5℃ *Test Time= 1000hrs	45 PCS (CL=90%; LTPD=5%)	MIL-STD-750D:1031 (1995) MIL-STD-883G:1008 (2006) JEITA ED-4701:200 201 (2001)
	Low Temperature Storage	Ta= -55 ± 5℃ *Test Time= 1000hrs	45 PCS (CL=90%; LTPD=5%)	JEITA ED-4701:200 202 (2001)
	Temperature Cycling	$100^\circ C \sim 25^\circ C \sim -40^\circ C \sim 25^\circ C$ 30mins 5mins 30mins 5mins *Test time: 200 Cycles	76 PCS (CL=90%; LTPD=3%)	MIL-STD-750D:1051 (1995) MIL-STD-883G:1010 (2006) JEITA ED-4701:100 105 (2001) JESD22-A104C (2005)
	Thermal Shock	$100 \pm 5\% \sim -30\% \pm 5\%$ $15 \text{mins}$ $15 \text{mins}$ *Test time: 200 Cycles (<20 secs transfer)	76 PCS (CL=90%; LTPD=3%)	MIL-STD-750D:1056 (1995) MIL-STD-883G:1011 (2006) MIL-STD-202G:107G (2002) JESD22-A106B (2004)
Environmental Test	Solder Resistance	T.sol = 260 ± 5℃  Dwell Time= 10±1 seconds  3mm from the base of the epoxy bulb	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-750D:2031(1995) JEITA ED-4701: 300 302 (2001)
	Solderability	T. sol = 245 $\pm$ 5°C Dwell Time= 5 $\pm$ 0.5 seconds (Lead Free Solder, Coverage $\geq$ 95% of the dipped surface)	11 PCS (CL=90%; LTPD=18.9%)	MIL-STD-750D:2026 (1995) MIL-STD-883G:2003 (2006) MIL-STD-202G:208H (2002) IPC/EIA J-STD-002 (2004)
	Soldering Iron	T. sol = $350 \pm 5$ °C  Dwell Time= $3.5 \pm 0.5$ seconds	11 PCS (CL=90%;LTPD=	MIL-STD-202G:208H (2002) JEITA ED-4701:300 302 (2001)

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